DATA SHEET

# EC

## **MOS Integrated Circuit** µPD65881GB-P03

### Product with functions equivalent to those of the $\mu$ PD71055 (parallel interface unit), using the gate array method

The µPD65881GB-P03 has an IP macro (product name: NA55A macro) included in CMOS gate array CMOS-N5, and is a product with functions equivalent to those achieved by the  $\mu$ PD71055 (programmable timer/counter, discontinued product).

The internal block functions and commands are the same as those of the  $\mu$ PD71055, so the  $\mu$ PD65881GB-P03 can be used as a substitute for the  $\mu$ PD71055.

This product is designed using the gate array method and has therefore some differences and cautions dependent on the gate array. Before adopting this product, note the disclaimer below and 3. CAUTIONS WHEN CONSIDERING ADOPTION OF THIS PRODUCT.

#### Disclaimer (Be sure to read)

- This product does not have functions equivalent to any similar non-NEC Electronics product. NEC Electronics shall assume no responsibility for any loss or damage incurred by our customers or by third parties resulting from the replacement of products similar to, but other than the  $\mu$ PD71055GB-10-3B4.
- NEC Electronics shall assume no responsibility for any loss or damage incurred by our customers or by third parties resulting from the use of this product outside the conditions described in the absolute maximum ratings, recommended operation range, and quality grades.

	Item	This Product	μPD71055	Reference		
Pa	art number (mark)	μPD65881GB-P03-3BS-A (658N55)	μPD71055GB-10-3B4 (standard NEC mark)	_		
Pa	ackage type	Only 44-pin QFP	QFP, DIP, QFJ	-		
	ackage shape (comparison 44-pin QFP)	The body size and package width and pin bending method are differ	4. PACKAGE DRAWING			
Fu	Inction of pin 1	IC (connection with external pin prohibited)				
Lead-free support		Yes	No	ORDERING INFORMATION		
	ecommended soldering nditions	IR60-207-3, partial heating	IR35-00-3, VP15-00-3, WS60-00-1, partial heating	5. RECOMMENDED SOLDERING CONDITIONS		
Ab	solute maximum ratings			2. ELECTRICAL		
	Power supply voltage	-0.5 to +6.0 (V)	-0.5 to +7.0 (V)	SPECIFICATIONS		
Input voltage Output voltage		-0.5 to +6.0 (V)	-0.5 to V <sub>DD</sub> +0.3 (V)			
		-0.5 to +6.0 (V)	-0.5 to V <sub>DD</sub> +0.3 (V)			
Re	ecommended operation	$T_A = -40$ to $+85^{\circ}C$ , $V_{DD} = 5 V \pm 10\%$				
range		This product does not guarantee				
DC characteristics		Partially different				
AC	C characteristics	This product has the following res D7 to D0: 150 pF or less P00 to P04, P17 to P10, P27 to P				

#### DIFFERENCES WITH THE µPD71055

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.

#### **ORDERING INFORMATION**

Part Number

Package

μPD65881GB-P03-3BS-A

44-pin plastic QFP (10x10)

**Remark** Products with -A at the end of the part number are lead-free products.

#### **QUALITY GRADES**

"Standard"

This product is intended to be used for applications such as computers, office equipment, communications equipment, test and measurement equipment, and home electronic appliances. It therefore cannot be used for the following applications.

Applications requiring special or specific grades, such as transportation equipment (automobiles, trains, ships, etc.), traffic control systems, medical equipment, aircraft equipment, and aerospace equipment.

Remark For details of quality grades, refer to Quality Grades on NEC Semiconductor Devices (C11531E).

#### 1. PIN LAYOUT

For the pin functions, refer to the  $\mu$ PD71055 Data Sheet (IC-1921).

Pin No.	I/O	Pin Name	Name of Pin on $\mu$ PD71055	Pin No.	I/O	Pin Name	Name of Pin on μPD71055
1	-	IC (V <sub>DD</sub> ) Note	NC	23	_	V <sub>DD</sub>	<i>←</i>
2	I	CSB	CS	24	I/O	D7	<i>←</i>
3	-	GND	<i>←</i>	25	I/O	D6	<i>←</i>
4	Ι	A1	$\leftarrow$	26	I/O	D5	$\leftarrow$
5	Ι	A0	$\leftarrow$	27	I/O	D4	$\leftarrow$
6	I/O	P27	$\leftarrow$	28	I/O	D3	$\leftarrow$
7	I/O	P26	$\leftarrow$	29	I/O	D2	$\leftarrow$
8	I/O	P25	$\leftarrow$	30	I/O	D1	$\leftarrow$
9	I/O	P24	$\leftarrow$	31	I/O	D0	$\leftarrow$
10	I/O	P20	$\leftarrow$	32	I	RESET	$\leftarrow$
11	I/O	P21	$\leftarrow$	33	-	NC	$\leftarrow$
12	I/O	P22	$\leftarrow$	34	-	NC	$\leftarrow$
13	I/O	P23	$\leftarrow$	35	I	WRB	WR
14	I/O	P10	$\leftarrow$	36	I/O	P07	$\leftarrow$
15	I/O	P11	$\leftarrow$	37	I/O	P06	$\leftarrow$
16	I/O	P12	$\leftarrow$	38	I/O	P05	$\leftarrow$
17	-	IC (GND) <sup>Note</sup>	$\leftarrow$	39	I/O	P04	$\leftarrow$
18	I/O	P13	$\leftarrow$	40	I/O	P03	$\leftarrow$
19	I/O	P14	$\leftarrow$	41	I/O	P02	<i>←</i>
20	I/O	P15	$\leftarrow$	42	I/O	P01	<i>←</i>
21	I/O	P16	<i>←</i>	43	I/O	P00	<i>←</i>
22	I/O	P17	$\leftarrow$	44	I	RDB	RD

**Note** This pin is connected to GND or  $V_{DD}$  in the chip. To enhance the power supply in order to handle noise, it can be connected to the power supply pin of the board to improve the noise resistance performance.

#### 2. ELECTRICAL SPECIFICATIONS

This chapter describes only the differences with the  $\mu$ PD71055. For electrical specifications other than those below, refer to the  $\mu$ PD71055 Data Sheet (IC-1921).

#### Absolute Maximum Ratings

Parameter	Symbol	Conditions	Ratings	Unit
Power supply voltage	VDD		-0.5 to +6.0	V
Input voltage	VI		-0.5 to +6.0	V
Output voltage	Vo		-0.5 to +6.0	V

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

#### **Recommended Operating Range**

This is the same as the  $\mu$ PD71055. This product does not guarantee operation at less than 4.5 V.

Parameter	Symbol	This Product			μPD71055			Unit		
		Condition	MIN.	TYP.	MAX.	Condition	MIN.	TYP.	MAX.	
Input voltage, high	Vін		2.29		VDD		2.2		V <sub>DD</sub> +0.3	V
Input voltage, low	VIL		0.00		0.77		-0.5		0.8	V
Output voltage, high	Vон	Іон =	VDD-0.1			Іон =	0.7×V <sub>DD</sub>			V
		0 mA				–400 μA				
		Іон =	VDD-0.4							
		3.0 mA								
Output voltage, low	Vol	Iol=			0.4	Iol=			0.4	V
		3 mA				2.5 mA				
Output current, low	lo∟		3.0				2.5			mA

#### DC Characteristics ( $V_{DD} = 5 V \pm 10\%$ , $T_A = -40 \text{ to } +85^{\circ}\text{C}$ )

#### **AC Characteristics**

These are similar to the  $\mu$ PD71055 characteristics, except for the following restrictions on load capacitance. Operation outside the range of these restrictions is not guaranteed.

D7 to D0: 150 pF or less P00 to P04, P17 to P10, P27 to P20: 40 pF or less

#### 3. CAUTIONS WHEN CONSIDERING ADOPTION OF THIS PRODUCT

When considering the adoption of this product, note the following points.

#### (1) Function check using product samples

Before adopting this product, make sure to request product samples from NEC Electronics to check the functions. Product samples are available free of charge.

When mounting this product onto different multiple printed circuit boards, extensively check the functions by changing the supply voltage to be supplied to the printed circuit boards as well as the temperature conditions for all printed circuit boards.

The standard number of product samples is five. When requesting product samples, communicate the following items to an NEC Electronics sales representative.

Your company name, your name, product application, the period of starting adoption, the number of products to be adopted

#### (2) Submitting the Approval Sheet

When normal operation has been confirmed and the adoption has been decided, complete a copy of the Approval Sheet (Appendix of this document) and submit it to NEC Electronics.

#### (3) Shipment inspection

Shipment inspection is performed for this product by using the  $\mu$ PD71055GB-10-3B4 shipment test pattern. The DC characteristics satisfy the gate array shipment inspection.

#### (4) Order amount

Orders from a minimum of 100 units, and in units of 100 are accepted.

#### (5) Package, packing form

The dimensions are partially different from the  $\mu$ PD71055GB-10-3B4. Refer to the package drawing and confirm that the product can actually be mounted. Dry pack tray packing is used for packing.

#### (6) Price

This product has a standard price. Please ask the NEC Electronics Sales Department for details.

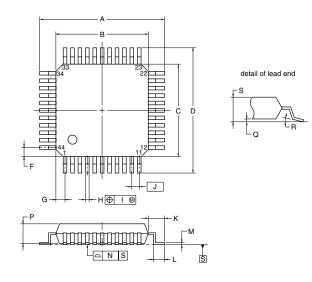
#### (7) Obtaining the $\mu$ PD71055 Data Sheet

The  $\mu$ PD71055 (original product) Data Sheet is available from the NEC Electronics Web site (http://www.necel.com/). The URL is as follows.

http://www.necel.com/nesdis/image/IC-1921B.pdf

#### 4. PACKAGE DRAWING

#### 44-PIN PLASTIC QFP (10x10)





ITEM	MILLIMETERS
А	13.2±0.2
В	10.0±0.2
С	10.0±0.2
D	13.2±0.2
F	1.0
G	1.0
н	0.37+0.08
1	0.16
J	0.8 (T.P.)
к	1.6±0.2
L	0.8±0.2
м	0.17+0.06
N	0.10
Р	2.7±0.1
Q	0.125±0.075
R	3°+7° -3°
S	3.0 MAX.
	S44GB-80-3BS-

#### 5. RECOMMENDED SOLDERING CONDITIONS

These products should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an NEC Electronicssales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditons	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 260°C, Time: 60 seconds max. (at 220°C or higher), Count: 3 times or less, Exposure limit: 7 days <sup>Note</sup> (after that, prebake at 125°C for 20 to 72 hours)	IR60-207-3
Partial heating	Pin temperature: 350°C max., Time: 3 seconds max. (per pin row)	_

**Note** After opening the dry pack, store it at 25°C or less and 65% RH or less for the allowable storage period.

Caution Do not use different soldering methods together (except for partial heating).

#### APPENDIX APPROVAL SHEET

Copy this page, and complete and confirm the required items. If you accept the conditions, sign and submit this sheet to NEC Electronics.

	<u>Ap</u>	oproval Sheet				
O: NEC Electronics	<u>(_)</u>					
We have confirmed t	hrough sample evaluations that the	e device functions as stated in the specifications and agree to use the				
device in accordance	with the boxes checked below in C	Confirmed Items.				
Company :		Date (yy/mm/dd):				
Name:		Department:				
Signature:		Title:				
heck the boxes b	elow, to indicate confirmation	on of related matters.				
Device		$\mu$ PD65881GB-P01-3BS-A ( $\mu$ PD71054 function compatible)				
(Part-Number)		( $\mu$ PD71051 function compatible)				
		(µPD71055 function compatible)				
NEC Electronics	Office					
Counterpart	Name					
Confirmed Items	Confirm the contents below and					
	All items must be confirmed an					
		priginal product ( $\mu$ PD71051/71054/71055) and notes for use of the size (s) is the Data Chart				
	function-compatible devi					
		actual application environment, using samples on before using in a new or different board or application set				
		he board with at least 4 layers and a stable power supply.				
		noise entering chips may be interpreted as being normal signals when				
		product is employed in a more advanced design process.				
dditional Informat	ion required:					
Demand/Forecast						

Demand/Forecast		
M/P starting time	(yy/mm/dd)	
Monthly Run-Rate	(units)	
Comment		
	•	

#### - NOTES FOR CMOS DEVICES -

#### **1** VOLTAGE APPLICATION WAVEFORM AT INPUT PIN

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (MAX) and  $V_{IH}$  (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (MAX) and  $V_{IH}$  (MIN).

#### (2) HANDLING OF UNUSED INPUT PINS

Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to V<sub>DD</sub> or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.

#### **③** PRECAUTION AGAINST ESD

A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.

#### **④** STATUS BEFORE INITIALIZATION

Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.

#### 5 POWER ON/OFF SEQUENCE

In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current.

The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.

#### **(6)** INPUT OF SIGNAL DURING POWER OFF STATE

Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.

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- "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots.
- "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support).
- "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC Electronics products is "Standard" unless otherwise expressly specified in NEC Electronics data sheets or data books, etc. If customers wish to use NEC Electronics products in applications not intended by NEC Electronics, they must contact an NEC Electronics sales representative in advance to determine NEC Electronics' willingness to support a given application.

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